

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE Guited States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandra, Virginia 22313-1450 (WWW.USDIO.gov)

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/677,182	10/02/2003	Jee-Soo Mok	LEPA121687	8329	
26389	7590 05/24/2005		EXAMINER		
CHRISTENSEN, O'CONNOR, JOHNSON, KINDNESS, PLLC 1420 FIFTH AVENUE			AHMED, S	AHMED, SHAMIM	
SUITE 2800			ART UNIT	PAPER NUMBER	
SEATTLE,	WA 98101-2347		1765		
		70 4 mm 4 4 4 17 mm 0 c /n 4 m00 c			

DATE MAILED: 05/24/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

			W_{\sim}
	Application No.	Applicant(s)	
	10/677,182	MOK ET AL.	
Office Action Summary	Examiner	Art Unit	
	Shamim Ahmed	1765	
The MAILING DATE of this communication app Period for Reply	pears on the cover sheet w	ith the correspondence add	ress
A SHORTENED STATUTORY PERIOD FOR REPL THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a repl - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statute Any reply received by the Office later than three months after the mailin earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a y within the statutory minimum of thi will apply and will expire SIX (6) MOI s, cause the application to become A	reply be timely filed rty (30) days will be considered timely. NTHS from the mailing date of this con BANDONED (35 U.S.C. § 133).	nmunication.
Status			
1) Responsive to communication(s) filed on <u>02 C</u> 2a) This action is FINAL . 2b) This 3) Since this application is in condition for alloware closed in accordance with the practice under E	s action is non-final. nce except for formal mat	•	merits is
Disposition of Claims			
4) ☐ Claim(s) <u>1-9</u> is/are pending in the application. 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) <u>1-9</u> is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/o			
Application Papers			
9) The specification is objected to by the Examine 10) The drawing(s) filed on <u>02 October 2003</u> is/are Applicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Examine 11.	: a)⊠ accepted or b)□ o drawing(s) be held in abeya tion is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFF	R 1.121(d).
Priority under 35 U.S.C. § 119		·	
a) All b) Some * c) None of: 1. Certified copies of the priority document 2. Certified copies of the priority document 3. Copies of the certified copies of the priority application from the International Bureau * See the attached detailed Office action for a list	s have been received. s have been received in A rity documents have beer u (PCT Rule 17.2(a)).	Application No n received in this National S	itage
Attachment(s)	_		
) ☑ Notice of References Cited (PTO-892) 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) ☑ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	Paper No(Summary (PTO-413) s)/Mail Date nformal Patent Application (PTO-	152)

Application/Control Number: 10/677,182 Page 2

Art Unit: 1765

DETAILED ACTION

Specification

1. The abstract of the disclosure is objected to because it is presented as more than one paragraph. Abstract should be in single paragraph and may not exceed 150 words in length. Correction is required. See MPEP § 608.01(b) [R-2].

Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter, which the applicant regards as his invention.
- 3. Claims 7-9 are rejected under 35 U.S.C. 112, second paragraph, as being indefinite for failing to particularly point out and distinctly claim the subject matter which applicant regards as the invention.
- 4. Regarding claim 7, lines 4-5, the phrase "a multilayer printed circuit board fabricated in a <u>parallel manner</u>" renders the claim indefinite because it is unclear what is meant by "a parallel manner".

Claim Rejections - 35 USC § 103

- 5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein

were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

7. Claims 1-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kamayachi et al (4,943,516) in view of Wolski et al (5,447,619).

Kamayachi et al disclose a process of forming a solder resist pattern on a printed circuit board (col.1, lines 7-20), wherein the process including the steps of:

- laminating or depositing a thermosetting resin on a printed circuit board (PCB) having circuits formed thereon, wherein the resin can be in a wet or dry state (semi-cured);
- the coating is then directly exposed to a laser beam through a photomask having a prescribed pattern;
- > post-curing the developed thermosetting resin pattern to form solder resist pattern (col.15, line 67-col.16, line 31).

Kamayachi et al remain silent about the pre-treating the printed circuit board before lamination step.

However, Wolski et al teach that it widely accepted practice in the manufacturing of printed circuit board (PCB) to pretreat or clean or microetch the circuit board using abrasion, scrubbing or chemical means for increasing bonding capability between the

circuit patterns in the copper-clad laminate and polymeric resist material (col.4, lines 52-col.5, lines 14).

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Wolski et al's teaching into Kamayachi et al's process for increasing bonding capability between the circuit patterns in the copper-clad laminate and polymeric resist material as taught by Wolski et al.

8. Claims 1-9 are rejected under 35 U.S.C. 103(a) as being unpatentable over Paulus (5,626,774) in view of Wolski et al (5,447,619).

Paulus discloses a process of forming solder resist mask on the surface of a multilayered printed circuit board, wherein both side of a copper foil is laminated with a partially cured thermosetting resin, which is then irradiating or ablated with laser through an etch resist mask (col.1, lines 62-col.2, lines 14 and col.3, lines 5-11).

Paulus remains silent about the pre-treating the printed circuit board before lamination step.

However, Wolski et al teach that it widely accepted practice in the manufacturing of printed circuit board (PCB) to pretreat or clean or microetch the circuit board using abrasion, scrubbing or chemical means for increasing bonding capability between the circuit patterns in the copper-clad laminate and polymeric resist material (col.4, lines 52-col.5, lines 14).

Therefore, it would have been obvious to one of ordinary skilled in the art at the time of claimed invention to combine Wolski et al's teaching into Kamayachi et al's

Application/Control Number: 10/677,182

Art Unit: 1765

process for increasing bonding capability between the circuit patterns in the copper-clad laminate and polymeric resist material as taught by Wolski et al.

Page 5

Conclusion

9. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Nakamura et al (6,221,972) disclose a process of forming photosensitive thermosetting resin on a printed circuit board and the coated resin film is irradiated with laser beam in order to form solder resist and then heat treating the developed resist pattern for curing the coated solder resist pattern (col.7, lines 22-47).

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Shamim Ahmed whose telephone number is (571) 272-1457. The examiner can normally be reached on M-Thu (7:00-5:30) Every Friday Off.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Nadine G. Norton can be reached on (571) 272-1465. The fax phone number for the organization where this application or proceeding is assigned is 703-872-9306.

Application/Control Number: 10/677,182

Art Unit: 1765

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Shamim Ahmed Primary Examiner Art Unit 1765 Page 6

SA May 17, 2005